Attorney Docket No.:1047 /HIROSE



DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I declare that:

My residence, post office address, and citizenship are as stated next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter that is claimed and for which a patent is sought on the invention entitled

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me specification	of which	
(Check one)	[]	is attached hereto.
	[X]	was filed on July 8, 2003 as patent application Serial No and was amended on (if any).
	[]	was filed on as PCT International Application No and was amended under PCT Article 19 or (if any).

I have reviewed and understand the contents of the specification identified above, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information that is material to the examination of the patent application identified above in accordance with 37 CFR §1.56(a).

I claim foreign priority benefits pursuant to 35 U.S.C. §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application from which priority is claimed:

Prior Foreign	Priority Claimed			
<u>Japan</u>	2002-199666	09 л	JLY 2002	Yes <u>X</u> No
(Country)	(Number)		onth/Year Filed)	100 11 110
_ Japan	2002-217925	26 Л	JLY 2002	Yes_X_ No
(Country)	(Number)	(Day/Month/Year Filed)		100_11 110
I claim the ben listed below:	efit pursuant to 35 U	J.S.C. §119(e) of any	United States provis	sional application(s)
Application Serial No.		Filing Date		
Application Serial No.		Filing Date		
disclosed in the paragraph of 35 37 CFR §1.56(a	far as the subject may prior United States U.S.C. §112, I ackr) effective between	S.C. §120 of any Unatter of each of the clapatent application(s) which was a constant of the filing date of the his patent application	aims of this patent ap in the manner provic disclose material info prior patent applicati	onlication is not
Application Ser	ial No.	Filing Date	Status (Pat.	./Pend./Aban.)
Application Ser	ial No.	Filing Date	Status (Pat.	/Pend./Aban.)
I appoint:				
**	: P	Aichael Tobias, Reg	32948	
my attorney with	full power of subst	itution and revocation	n to prosecute my an	plication for Latters

my attorney with full power of substitution and revocation to prosecute my application for Letters Patent identified above and to transact all business in the Patent and Trademark Office connected with that patent application.

I authorize my attorney to accept and follow instructions from S. Hirose and Associates regarding any matter related to the preparation, examination, grant, and maintenance of the application identified above, any continuation, continuation-in-part, or divisional based on the patent application identified above, and any patent issuing from that patent application, until I or my assigns withdraw this authorization in writing.

I direct that correspondence concerning this application be sent to Michael Tobias, #40, 1717 K Street N.W., Suite 613, Washington, D.C. 20036, telephone (301) 587-6541.

I declare that all statements made here based on my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful, false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful, false statements may jeopardize the validity of the patent application identified above or any patent issuing from the patent application identified above.

Full name of sole or first inventor: Masazumi AMAGAI
Inventor's signature Masazum; Amagai
Date 15 Dec 2003 Residence: Tsukuba-shi, Ibaraki Citizenship: Japan Post Office Address: 2-4-3, Ninomiya, Tsukuba-shi, Ibaraki, Japan
Full name of second joint inventor, if any: Masako WATANABE
Inventor's signature <u>Masako Watanabe</u>
Date 15 Dec 2003 Residence: Oita-shi, Oita Citizenship: Japan Post Office Address: 7-2, Kamishiraki, Oita-shi, Oita, Japan
Full name of third joint inventor, if any: Kensho MURATA
Inventor's signature Kensho Muratio
Date 15 Dec 2003 Residence: Beppu-shi, Oita Citizenship: Japan Post Office Address: 10kumi, Osaka, Beppu-shi, Oita, Japan

[X]

Additional inventors are being named on separately numbered sheets attached hereto.

Osama Munekata Inventor's signature ____ Date 28 NOV 2003 Residence: Souka-shi, Saitama Citizenship: Japan Post Office Address: 4-20-18, Hanaguri, Souka-shi, Saitama, Japan Full name of fifth joint inventor, if any: Yoshitaka TOYODA Inventor's signature Yoshituka Toyoda Date 28 Nov. 2003 Residence: Satte-shi, Saitama Citizenship: Japan Post Office Address: 4-16-21, Kahinata, Satte-shi, Saitama, Japan Full name of sixth joint inventor, if any: Minoru UESHIMA Inventor's signature Minoru Veshima Date 28 Nov. 2003 Residence: Misato-shi, Saitama Citizenship: Japan Post Office Address: 2-483-1, Takano, Misato-shi, Saitama, Japan Full name of seventh joint inventor, if any: Tsukasa OHNISHI Inventor's signature Tsuka sa Ohnishi Date 28 Nov. 2003 Residence: Souka-shi, Saitama Citizenship: Japan Post Office Address: 405, Yatsuka-cho, Souka-shi, Saitama, Japan

Full name of fourth joint inventor, if any: Osamu MUNEKATA

Full name of eighth joint inventor, if any: Hiroshi OKADA

Inventor's signature Hiroshi Okada

Date 3 December, 2003 Residence: Souka-shi, Saitama

Citizenship: Japan

Post Office Address: 405-307, Yatsuka-cho, Souka-shi, Saitama, Japan